Thank you for your interest in the SEI-St. Louis Chapter Structural Engineering Scholarship. The scholarship committee has prepared the following summary to provide you some background. Please review the entire application package. We look forward to receiving your application.

INTENT

The SEI-St. Louis Chapter Structural Engineering Scholarship fund was established by the St. Louis Chapter of the Structural Engineering Institute in 2013. The 2019 scholarship fund will provide an award total of $1,500. The scholarship committee will award the full amount to a single applicant or split the $1,500 between two applicants based upon the merit of the applications received.

The intent of the St. Louis Chapter of SEI is to provide funding to a graduate student who is pursuing a Master’s degree in Structural or Civil Engineering with a structural emphasis at a Midwestern university during the Fall 2019 term. Additionally, the Chapter seeks to assist those with a passion for the discipline and a desire to promote the profession, specifically through the Structural Engineering Institute of the American Society of Civil Engineer.

The SEI-St. Louis Chapter Structural Engineering Scholarship will be awarded in 2019 for the fall session. Procedures for subsequent years may be revised from those contained herein.
SCHEDULE

The proposed schedule for application and award of the 2019 SEI-St. Louis Chapter Structural Engineering Scholarship is as follows:

June 1, 2019   - Deadline for RECEIPT of applications (not postmarking/shipping)
September 2019 - Award scholarship(s) at ASCE St. Louis Section Annual Dinner
                  (Attendance preferred but not required)

SCHOLARSHIP STRUCTURE

Criteria: The SEI-St. Louis Chapter Structural Engineering Scholarship is open to all students that have graduated with, or will receive before July 1, 2019, a B.S. degree and have been accepted to a Midwestern university for graduate studies in Structural or Civil Engineering with a structural emphasis. The university awarding the B.S. degree and graduate degree shall have an ABET-accredited B.S. in Civil Engineering program. The intent of the scholarship is to provide financial assistance for structural engineering studies towards a master’s degree. The scholarship awardee will be selected annually based on their enthusiasm for structural engineering, their appreciation of the importance that field experience plays in the professional growth of an engineer, and their academic record.

Award Value: The total scholarship fund will be valued at $1,500 for 2019. One or two graduate scholarships will be awarded. If two scholarships are awarded, the $1,500 will be divided as the scholarship committee sees fit.

Award Notification: It is intended that the awardee(s) will be notified in writing by the chairman of the scholarship committee. The name and biographical details of the awardee will be submitted to the St. Louis Section Newsletter. To increase awareness of the SEI-St. Louis Chapter Structural Engineering Scholarship within the Midwest, the committee would strongly encourage the awardee to attend the St. Louis Section, ASCE Annual Dinner or a monthly meeting, and be involved with their university’s ASCE Student Chapter.

Scholarship Committee: The SEI-St. Louis Chapter Structural Engineering Scholarship is administered by a subcommittee within the St. Louis SEI Chapter. The Scholarship Committee reserves the right to the final awardee decision and the number of scholarships awarded.
St. Louis Section, American Society of Civil Engineers
SEI – St. Louis Chapter Structural Engineering Scholarship
2019 Application Form

ELIGIBILITY REQUIREMENTS:

An applicant must: 1- have received a B.S. Degree or will receive such degree before July 1, 2019; and, 2- be accepted to or presently enrolled in a Master’s Degree program in Structural or Civil Engineering with a structural emphasis at a department which has an ABET – accredited B.S. in Civil Engineering program. Applicants are encouraged to be members of ASCE. Visit the ASCE St. Louis Section web site at http://sections.asce.org/stlouis for scholarship forms and ASCE membership applications.

APPLICATION PROCEDURES:

A complete scholarship application package must be received by the SEI-St. Louis Chapter Structural Engineering Scholarship Committee by the deadline indicated below. The package must include a complete scholarship application (signed) and current official transcript(s). Letters of recommendation may be submitted separately, although we prefer that you submit all application materials together. Only complete applications will be considered.

Send all application materials to: Stephanie Spann
David Mason and Associates
800 South Vandeventer Ave.
St. Louis, MO  63110

DEADLINE FOR RECEIPT:  June 1, 2019

HELPFUL HINTS

♦ We suggest you type your application, although an application legibly printed in blue or black ink is acceptable. Neatness counts! No matter how good your credentials, carelessly completed applications will be evaluated unfavorably.
 ♦ Obtain letters of recommendation from people you know well who can provide details about your academic performance, goals and work habits. Two letters of recommendation are required. Up to three recommendation letters are allowed. They may come from teachers, counselors, employers and colleagues. Letters from friends or relatives will not be accepted. Letters of recommendation are not confidential. Please give your sponsors ample time to write the letters and confirm that they will submit the letters before the deadline.
 ♦ Have someone proofread your application materials.
St. Louis Section, American Society of Civil Engineers
SEI – St. Louis Chapter Structural Engineering Scholarship
2019 Application Form

(Type, or print neatly using blue or black ink. Illegible applications will be rejected.)

1. NAME ____________________________________________________________________

   Last     First    Middle

2. ASCE MEMBERSHIP NUMBER _____________ ( _ check if applying for membership)

3. E-MAIL____________________________________________________________________

4. LOCAL MAILING ADDRESS

   ___________________________________________________
   Number and Street

   ___________________________________________________
   City________________________________________________
   State  ZIP Code  County

   PHONE NUMBER: (____) __________________________

5. PERMANENT OR SUMMER 2019 MAILING ADDRESS (Complete if different from #3)

   ___________________________________________________
   Number and Street

   ___________________________________________________
   City________________________________________________
   State  ZIP Code  County

5. BIRTHDATE ____/____/____

   mo.    day      yr.

6. CLASS LEVEL ___ Senior certain to receive their degree by July 1, 2019
   ___ Graduate Student - M.S.

7. CURRENT ACADEMIC MAJOR ________________________________________________
St. Louis Section, American Society of Civil Engineers
SEI – St. Louis Chapter Structural Engineering Scholarship
2019 Application Form

8. COLLEGES/UNIVERSITIES ATTENDED (*List current school first*)

<table>
<thead>
<tr>
<th>Name</th>
<th>City, State</th>
<th>Dates Attended</th>
<th>Degree Received</th>
<th>GPA</th>
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9. GRADUATE SCHOOL AND EXPECTED DATE OF GRADUATION

__________________________________________________________

(Institution, Quarter/Semester and Year)

10. EXTRACURRICULAR INVOLVEMENT (*Include memberships, offices and activities from high school, college, community and volunteer organizations. Add an additional sheet if necessary.*)

High School: ______________________________________________________

College: __________________________________________________________

Community/Volunteer: ______________________________________________

11. HONORS AND AWARDS (*Include special awards, prizes, scholarships and recognition. List the school or organization that granted the award. Add an additional sheet if necessary.*)

__________________________________________________________

__________________________________________________________

__________________________________________________________
12. EMPLOYMENT HISTORY (Include job information for your past three jobs. List the most recent job first.)

<table>
<thead>
<tr>
<th>Name of Firm</th>
<th>City, State</th>
<th>Dates Employed</th>
<th>Your Duties</th>
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</table>

13. PERSONAL STATEMENT – Provide a 1 page (max.) narrative describing why you were drawn to study structural engineering, what your dream job in structural engineering would entail, and/or how you perceived structural engineering benefits society as a whole.

14. NAME AND PHONE NUMBER OF SPONSORS (Two sponsors are required, a third is optional. See Letter of Recommendation form at the end of this application.)

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<thead>
<tr>
<th>Name</th>
<th>E-mail Address</th>
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<tbody>
<tr>
<td>Sponsor 1:</td>
<td>_________________________________</td>
</tr>
<tr>
<td>Sponsor 2:</td>
<td>_________________________________</td>
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<tr>
<td>Sponsor 3:</td>
<td>_________________________________</td>
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15. OFFICIAL TRANSCRIPTS ENCLOSED _____________ (Check Here)

CERTIFICATION AND AUTHORIZATION RELEASE

I certify that all information I have provided on this application is true to the best of my knowledge.

I authorize the St. Louis Section, SEI, to release letters of recommendation, applications and accompanying documents and to publicize my scholarship award if I am a recipient.

Signature: _________________________________ Date: _____________
INSTRUCTIONS: Thank you for participating in the application process for the year 2019 SEI – St. Louis Chapter Structural Engineering Scholarship. So that we may fully consider the applicant’s qualifications for the scholarship, please complete this form and return it to the applicant for submittal OR mail it directly to:

Stephanie Spann, Vice Chairman – SEI Scholarship Committee,
800 South Vandeventer Ave.
St. Louis, MO  63110

Applicant’s Name: ______________________________________________________________

This form must be RECEIVED by June 1, 2019. This is not confidential and the student may view the statement upon request. The applicant may submit this letter with the applicant’s scholarship submission.

Your Name: ____________________________________________________________________
Occupation: _______________________ Employer: __________________________________
Address: ______________________________________________________________________
City, State, Zip: __________________________________________________________________
Daytime Phone: ________________________ e-mail: _____________________________
Relationship to Applicant: __________________________________________

QUESTIONNAIRE  

1. How long have you known the applicant? ___________

2. How would you rate the applicant’s motivation for learning? P  F  G  E  Unknown

3. How would you rate the applicant’s prospects for a successful career in the structural engineering? P  F  G  E  Unknown

4. How would you rate the applicant’s enthusiasm for the structural engineering profession? P  F  G  E  Unknown

5. How well does the applicant get along with others? P  F  G  E  Unknown

6. How would you rate the applicant's professional ability? P  F  G  E  Unknown

7. How well does the applicant follow through on commitments? P  F  G  E  Unknown

8. Additional Comments - See attached page
COMMENTS

Please use this section, or attach a letter, to provide additional information regarding why this applicant should be selected for the scholarship. It is suggested that your comments include the following: general and special abilities the applicant possesses, present and potential leadership qualities of the applicant, and the applicant’s commitment to the structural engineering profession.

____________________________________  ______________________
Signature       Date